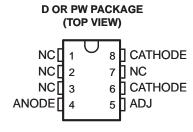


# 2.5-V INTEGRATED REFERENCE CIRCUIT

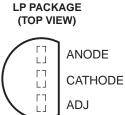
### **FEATURES**

- Excellent Temperature Stability
- Initial Tolerance: 0.2% Max
- Dynamic Impedance: 0.6 Ω Max

- Wide Operating Current Range
- Directly Interchangeable With LM136
- Needs No Adjustment for Minimum Temperature Coefficient



NC - No internal connection



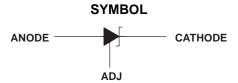
### DESCRIPTION/ORDERING INFORMATION

The LT1009 reference circuit is a precision-trimmed 2.5-V shunt regulator featuring low dynamic impedance and a wide operating current range. The maximum initial tolerance is  $\pm 5$  mV in the LP package and  $\pm 10$  mV in the D and PW packages. The reference tolerance is achieved by on-chip trimming, which minimizes the initial voltage tolerance and the temperature coefficient,  $\alpha_{V7}$ .

Although the LT1009 needs no adjustments, a third terminal (ADJ) allows the reference voltage to be adjusted ±5% to eliminate system errors. In many applications, the LT1009 can be used as a terminal-for-terminal replacement for the LM136-2.5, which eliminates the external trim network.

The LT1009 uses include 5-V system references, 8-bit analog-to-digital converter (ADC) and digital-to-analog converter (DAC) references, and power-supply monitors. The device also can be used in applications such as digital voltmeters and current-loop measurement and control systems.

The LT1009C is characterized for operation from 0°C to 70°C. The LT1009I is characterized for operation from –40°C to 85°C.





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# ORDERING INFORMATION(1)

T <sub>A</sub>	PACI	KAGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SOIC - D	Tube of 75	LT1009CD	1009C
	30IC - D	Reel of 2500	LT1009CDR	- 1009C
		Bulk of 1000	LT1009CLP	
0°C to 70°C	TO-226/TO-92 – LP	Ammo of 2000	LT1009CLPM	LT1009C
		Reel of 2000	LT1009CLPR	
	TCCOD DW	Tube of 150	LT1009CPW	10000
	TSSOP – PW	Reel of 2000	LT1009CPWR	1009C
	SOIC - D	Tube of 75	LT1009ID	40001
	201C – D	Reel of 2500	LT1009IDR	10091
		Bulk of 1000	LT1009ILP	
–40°C to 85°C	TO-226/TO-92 – LP	Ammo of 2000	LT1009ILPM	LT1009I
		Reel of 2000	LT1009ILPR	
	TOCOD DW	Tube of 150	LT1009IPW	40001
	TSSOP – PW	Reel of 2000	LT1009IPWR	10091

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

# **SCHEMATIC** CATHODE Q14 Q11 **24 k**Ω **6.6** $\mathbf{k}\Omega$ **24 k**Ω ≷ Q8 Q7 20 pF Q10 10 $k\Omega$ $\mathbf{500}\,\Omega$ Q9 30 $\mathbf{k}\Omega$ Q4 ADJ Q1 6.6 $\mathbf{k}\Omega$ Q6 Q3 Q12 Q13 **720** Ω ≶ **ANODE**

NOTE: All component values shown are nominal.



# ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$I_R$	Reverse current			20	mA
I <sub>F</sub>	Forward current			10	mA
		D package		97	
$\theta_{JA}$	Package thermal impedance (2)(3)	LP package		140	°C/W
		PW package		149	
$T_{J}$	Operating virtual junction temperature			150	°C
T <sub>stg</sub>	Storage temperature range		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## **RECOMMENDED OPERATING CONDITIONS**

			MIN	MAX	UNIT
т	Operating free air temperature range	LT1009C	0	70	°C
1 A	Operating free-air temperature range	LT1009I	-40	85	

<sup>(2)</sup> Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.

<sup>(3)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.



### **ELECTRICAL CHARACTERISTICS**

at specified free-air temperature

	PARAMETER		TEST CONDITIONS		L	T1009C		LT1009I			UNIT	
ľ					MIN	TYP	MAX	MIN	TYP	MAX	UNII	
			D/PW package	25°C	2.49	2.5	2.51	2.49	2.5	2.51		
V	Reference voltage	I <sub>7</sub> = 1 mA	LP package		2.495	2.5	2.505	2.495	2.5	2.505	V	
V <sub>Z</sub>	Reference voltage	12 = 1 111A	D/PW package		2.485		2.515	2.475		2.525	V	
			LP package	Full range	2.491		2.509	2.48		2.52		
$V_{F}$	Forward voltage	$I_F = 2 \text{ mA}$		25°C	0.4		1	0.4		1	V	
	A divistment range	$I_Z = 1 \text{ mA},$ $V_{ADJ} = GNI$	O to V <sub>Z</sub>	25°C	125			125			mV	
	Adjustment range	$I_Z = 1 \text{ mA},$ $V_{ADJ} = 0.6$	$I_Z = 1 \text{ mA},$ $V_{ADJ} = 0.6 \text{ V to } V_Z - 0.6 \text{ V}$		45			45			IIIV	
	Change in reference	D/PW package					5			15		
$\Delta V_{Z(temp)}$	voltage with temperature	LP package	e	Full range			4			15	mV	
	Average temperature			0°C to 70°C		15	25		15	25	ppm/	
$\alpha V_Z$	coefficient of reference voltage (2)	$I_Z = 1 \text{ mA},$	V <sub>ADJ</sub> = open	-40°C to 85°C					20	35	°C	
۸۱/	Change in reference	I - 400 · A	to 10 m/	25°C		2.6	10		2.6	6	mV	
$\Delta V_Z$	voltage with current	$12 = 400  \mu A$	$I_Z = 400 \mu\text{A} \text{ to } 10 \text{mA}$				12			10	IIIV	
$\Delta V_Z/\Delta t$	Long-term change in reference voltage	$I_Z = 1 \text{ mA}$	I <sub>Z</sub> = 1 mA			20			20		ppm/ khr	
7	Potoronoo impodonoo	1 - 1 m^		25°C		0.3	1		0.3	1	Ω	
$Z_Z$	Reference impedance	IZ = I IIIA		Full range			1.4			1.4	12	

- (1) Full range is 0°C to 70°C for the LT1009C and -40°C to 85°C for the LT1009I.
- (2) The deviation parameter V<sub>Z(dev)</sub> is defined as the difference between the maximum and minimum values obtained over the recommended operating temperature range, measured at I<sub>Z</sub> = 1 mA. The average full-range temperature coefficient of the reference voltage (αV<sub>Z</sub>) is defined as:

$$|\alpha V_z| \left(\frac{ppm}{{}^{\circ}C}\right) = \frac{\left(\frac{V_{z(dev)}}{V_z \text{ at } 25{}^{\circ}C}\right) \times 10^6}{\Delta T_A}$$
Maximum  $V_z$ 

$$Maximum V_z$$

$$V_{z(dev)} \text{ at } I_z = 1 \text{ mA}$$

 $\alpha V_Z$  can be positive or negative, depending upon whether the minimum  $V_Z$  or maximum  $V_Z$ , respectively, occurs at the lower temperature.

For example, at  $I_Z$  = 1 mA, maximum  $V_Z$  = 2501 mV at 30°C, minimum  $V_Z$  = 2497 mV at 0°C,  $V_Z$  = 2500 mV at 25°C,  $\Delta T_A$  = 70°C for LT1009C:

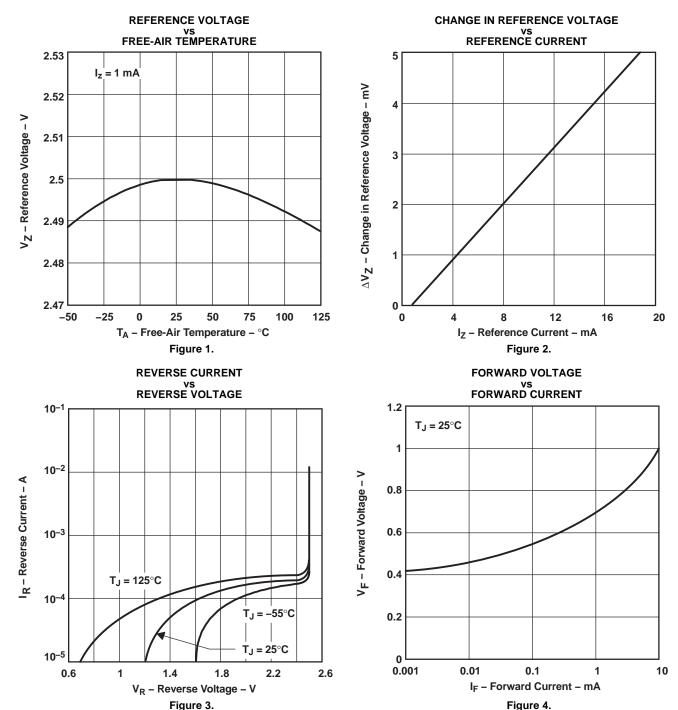
$$|\alpha V_z| = \frac{\left(\frac{4 \text{ mV}}{2500 \text{ mV}}\right) \times 10^6}{70^{\circ}\text{C}} \approx 23 \frac{\text{ppm}}{^{\circ}\text{C}}$$

Because minimum V<sub>7</sub> occurs at the lower temperature, the coefficient in this example is positive.



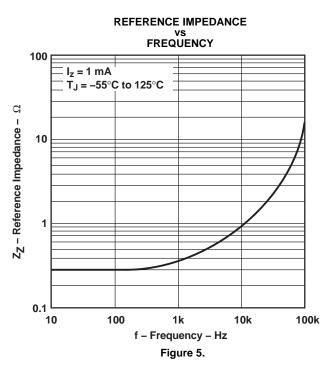
## **TYPICAL CHARACTERISTICS**

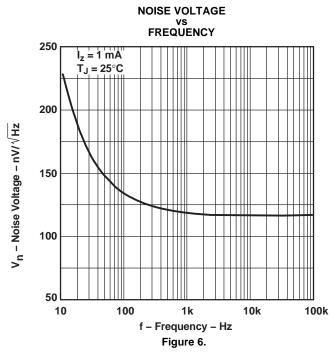
Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

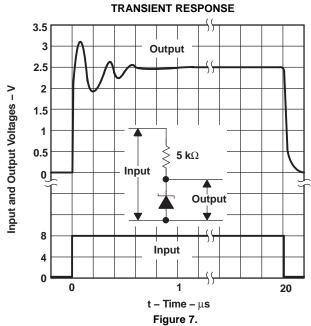




# **TYPICAL CHARACTERISTICS (continued)**

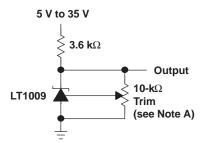








## **APPLICATION INFORMATION**



A. This does not affect temperature coefficient. It provides ±5% trim range.

### Figure 8. 2.5-V Reference

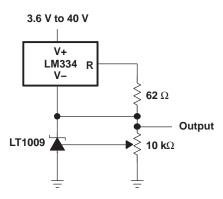


Figure 9. Adjustable Reference With Wide Supply Range

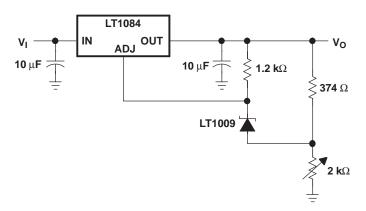


Figure 10. Power Regulator With Low Temperature Coefficient



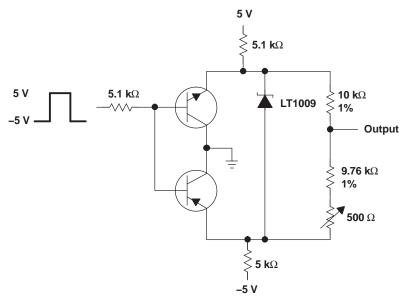


Figure 11. Switchable ±1.25-V Bipolar Reference

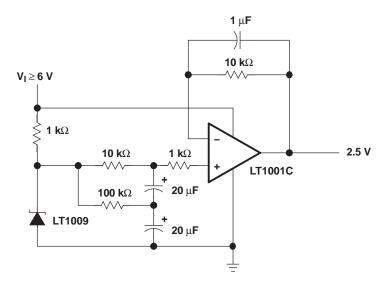


Figure 12. Low-Noise 2.5-V Buffered Reference



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### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LT1009CD	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	1009C	Samples
LT1009CDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	1009C	Samples
LT1009CLP	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	LT1009C	Samples
LT1009CLPM	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	LT1009C	Samples
LT1009CLPR	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	LT1009C	Samples
LT1009CPWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	1009C	Samples
LT1009ID	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	10091	Samples
LT1009IDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	10091	Samples
LT1009ILP	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	LT1009I	Samples
LT1009ILPR	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	LT1009I	Samples
LT1009IPWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	10091	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

# PACKAGE OPTION ADDENDUM

www.ti.com 1-Jan-2024

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF LT1009:

Military: LT1009M

NOTE: Qualified Version Definitions:

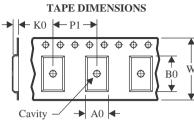
Military - QML certified for Military and Defense Applications

**PACKAGE MATERIALS INFORMATION** 

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## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LT1009CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LT1009CPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LT1009IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LT1009IPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1



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### \*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LT1009CDR	SOIC	D	8	2500	340.5	338.1	20.6
LT1009CPWR	TSSOP	PW	8	2000	367.0	367.0	35.0
LT1009IDR	SOIC	D	8	2500	340.5	338.1	20.6
LT1009IPWR	TSSOP	PW	8	2000	367.0	367.0	35.0

# **PACKAGE MATERIALS INFORMATION**

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## **TUBE**



### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LT1009CD	D	SOIC	8	75	507	8	3940	4.32
LT1009ID	D	SOIC	8	75	507	8	3940	4.32



SMALL OUTLINE INTEGRATED CIRCUIT



# NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



### NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





SMALL OUTLINE PACKAGE



### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153, variation AA.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040001-2/F



TO-92 - 5.34 mm max height

TO-92



### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.
- 3. Lead dimensions are not controlled within this area.4. Reference JEDEC TO-226, variation AA.
- 5. Shipping method:

  - a. Straight lead option available in bulk pack only.
     b. Formed lead option available in tape and reel or ammo pack.
  - c. Specific products can be offered in limited combinations of shipping medium and lead options.
  - d. Consult product folder for more information on available options.



TO-92





TO-92





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